October 2001

FAIRCHILD

FDN327N

N-Channel 1.8 Vgs Specified PowerTrench[®] MOSFET

General Description

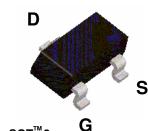
This 20V N-Channel MOSFET uses Fairchild's high voltage PowerTrench process. It has been optimized for power management applications.

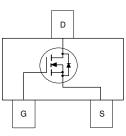
Applications

- Load switch
- Battery protection
- Power management

Features

- Low gate charge (4.5 nC typical)
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





SuperSOT[™]-3

Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter			Ratings	Unite	
V _{DSS}	Drain-Source Voltage			20	V	
V _{GSS}	Gate-Source Voltage			± 8		
I _D	Drain Currer	nt – Continuous	(Note 1a)	2	A	
		– Pulsed		8		
P _D	Power Dissipation for Single Operation		(Note 1a)	0.5	W	
			(Note 1b)	0.46		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150		
Therma	I Charact	eristics				
R _{eJA}	Thermal Resistance, Junction-to-Ambient (Note 1a)			250	°C/W	
R _{eJC}	Thermal Resistance, Junction-to-Case (Note 1)			75	°C/W	
Packag	e Marking	g and Ordering In	formation		·	
Device Marking		Device	Reel Size	Tape width	Quantity	
327		FDN327N	7"	8mm	3000 units	

©2001 Fairchild Semiconductor Corporation

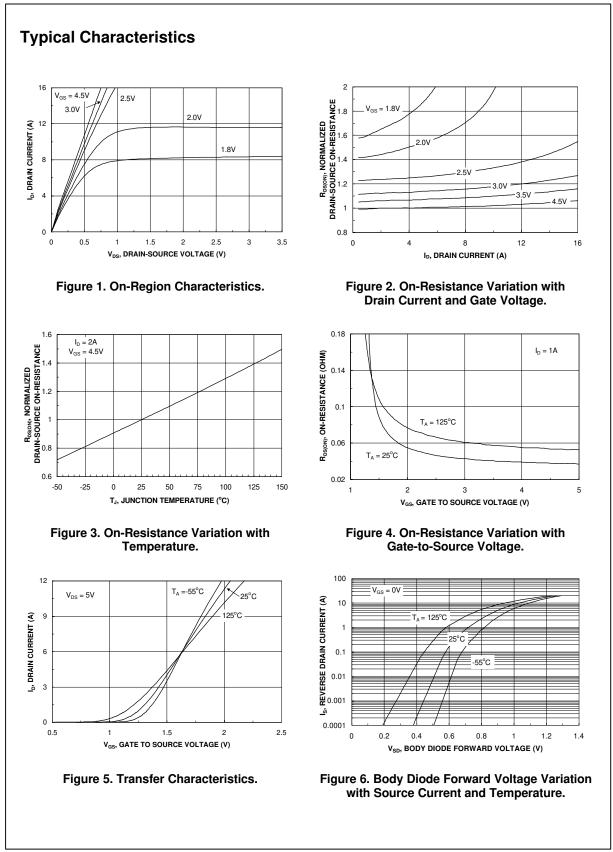
FDN327N

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	20			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A,Referenced to 25°C		12		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 16 V$, $V_{GS} = 0 V$			1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V, \qquad V_{DS} = 0 V$			100	nA
GSSR	Gate-Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)	·	•		•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.4	0.7	1.5	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \text{Referenced to } 25^{\circ}\text{C}$		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = 4.5 \ V, & I_D = 2.0 \ A \\ V_{GS} = 2.5 \ V, & I_D = 1.9 \ A \\ V_{GS} = 1.8 \ V, & I_D = 1.6 \ A \\ V_{GS} = 4.5 \ V, & I_D = 2 \ A, \ T_J = 125^\circ C \end{array} $		40 49 65 55	70 80 120 103	mΩ
D(on)	On-State Drain Current	$V_{GS} = 4.5V, V_{DS} = 5V$	8			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5V$, $I_D = 2A$		11		S
-	Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$		423		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		87		pF
C _{rss}	Reverse Transfer Capacitance			48		pF
Switchin	ng Characteristics (Note 2)					
d(on)	Turn–On Delay Time	$V_{DD} = 10 V, \qquad I_D = 1 A,$		6	12	ns
r	Turn–On Rise Time	$V_{GS} = 4.5 \text{ V}, \qquad R_{GEN} = 6 \Omega$		6.5	13	ns
d(off)	Turn–Off Delay Time	7		14	29	ns
f	Turn–Off Fall Time			2	4	ns
Qg	Total Gate Charge	$V_{\text{DS}} = 10 \text{ V}, \qquad I_{\text{D}} = 2 \text{ A},$		4.5	6.3	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 4.5 V$		0.89		nC
Q _{gd}	Gate–Drain Charge			0.95		nC
Drain-So	ource Diode Characteristics	and Maximum Ratings				
s	Maximum Continuous Drain-Source	Diode Forward Current			0.42	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \ V, I_S = 0.42 \ A (Note 2)$		0.6	1.2	V
	um of the junction-to-case and case-to-ambient the is. R _{6JC} is guaranteed by design while R _{6CA} is dete a) 250°C/W when mounted on a 0.02 in ² pad of 2 oz. copper.			l as the sol	der mounti	ng surface

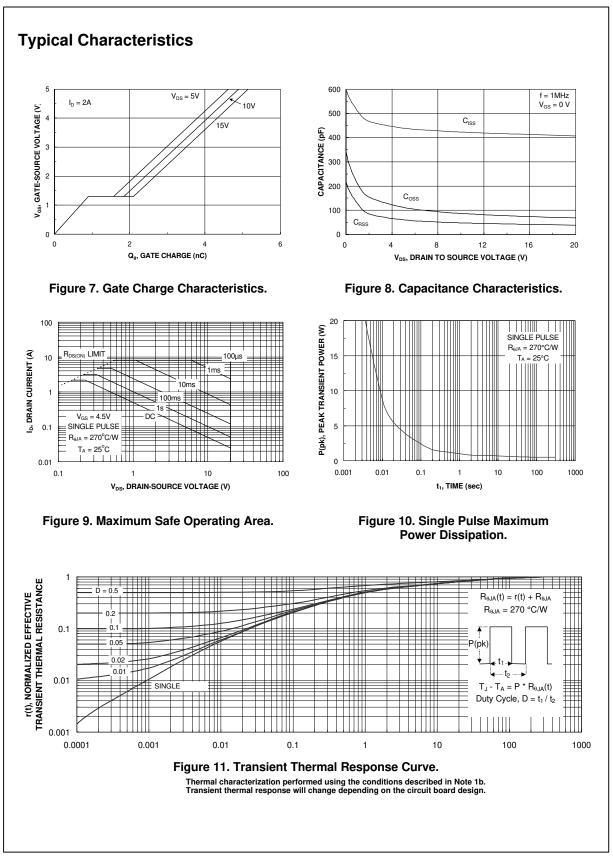
Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%

FDN327N Rev C (W)



FDN327N



FDN327N

FDN327N Rev C (W)

TRADEMARKS

The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks.

ACEx™ Bottomless™ CoolFET™ *CROSSVOLT*™ DenseTrench™ DOME™ **EcoSPARK™** E²CMOS[™] EnSigna™ FACT™ FACT Quiet Series[™] FAST ® FASTr™ FRFET™ GlobalOptoisolator[™] POP[™] GTO™ HiSeC™ ISOPLANAR™ LittleFET™ MicroFET™ MicroPak™ MICROWIRE™

OPTOLOGIC™ OPTOPLANAR™ PACMAN™ Power247™ PowerTrench[®] QFET™ OS™ QT Optoelectronics[™] Quiet Series[™] SILENT SWITCHER®

SMART START™ VCX™ STAR*POWER™ Stealth™ SuperSOT™-3 SuperSOT[™]-6 SuperSOT[™]-8 SyncFET™ TinyLogic™ TruTranslation™ UHC™ UltraFET[®]

STAR*POWER is used under license

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY. FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS. NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Product Status	Definition		
Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.		
Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.		
Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconduct The datasheet is printed for reference information of		
	Formative or In Design First Production Full Production		

Rev. H4